



# SSC8631GS1

## N- and P-Channel Complementary, MOSFET

### ➤ Features

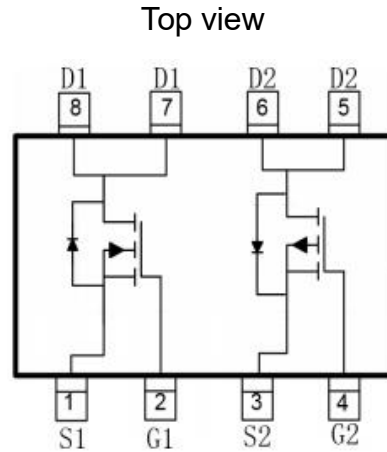
#### N-Channel

VDS	VGS	RDSON Typ.	ID
30V	±20V	22mR@10V	6A
		35mR@4V5	

#### P-Channel

VDS	VGS	RDSON Typ.	ID
-30V	±20V	27mR@-10V	-6A
		39mR@-4V5	

### ➤ Pin configuration



### ➤ Description

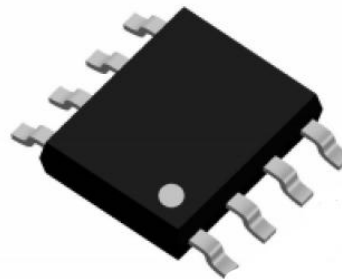
SSC8631GS1 uses advanced trench technology to provide excellent RDSON and low gate charge. The complementary MOSFETS may be used to form a level shifted high side switch, and for a host of other applications.

### ➤ Applications

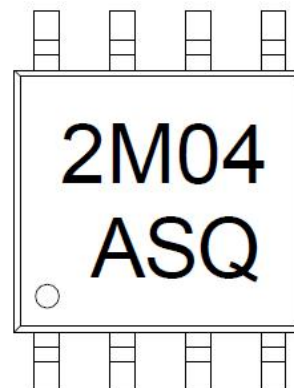
- Inverter
- CCFL Driver

### ➤ Ordering Information

Device	Package	Shipping
SSC8631GS1	SOP8	4000/Reel



SOP8



Marking



➤ **Absolute Maximum Ratings**( $T_A=25^{\circ}\text{C}$  unless otherwise noted)

Symbol	Parameter	N-Channel	P-Channel	Unit
$V_{DSS}$	Drain-to-Source Voltage	30	-30	V
$V_{GSS}$	Gate-to-Source Voltage	$\pm 20$	$\pm 20$	V
$I_D$	Continuous Drain Current	6	-6	A
$I_{DM}$	Pulsed Drain Current	35	-31	A
$P_D$	Power Dissipation	1	1	W
$T_J$	Operation junction temperature	-55 to 150	-55 to 150	$^{\circ}\text{C}$
$T_{STG}$	Storage temperature range	-55 to 150	-55 to 150	$^{\circ}\text{C}$

➤ **Thermal Resistance Ratings**( $T_A=25^{\circ}\text{C}$  unless otherwise noted)

Symbol	Parameter	Typical	Maximum	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance		129	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Junction-to-Case Thermal Resistance		70	

➤ **Electronics Characteristics**( $T_A=25^{\circ}\text{C}$  unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit	
$V_{(BR)DSS}$	Drain-Source	$V_{GS}=0V, I_D=250\mu\text{A}$	N-CH	30		V	
	Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu\text{A}$	P-CH	-30			
$V_{GS(th)}$	Gate Threshold	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	N-CH	1	1.5	3	V
	Voltage	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	P-CH	-1	-1.5	-3	
$R_{DS(on)}$	Drain-Source	$V_{GS}=10V, I_D=5A$	N-CH		22	28	mR
		$V_{GS}=10V, I_D=-5A$	P-CH		27	35	
	On-Resistance	$V_{GS}=4.5V, I_D=2A$	N-CH		35	40	
		$V_{GS}=-4.5V, I_D=-2A$	P-CH		39	50	

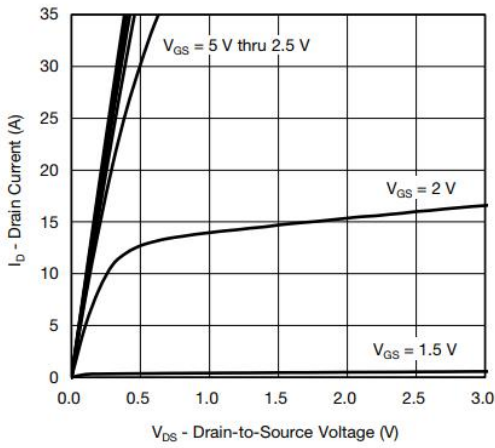


Symbol	Parameter	Test Conditions		Min	Typ.	Max	Unit
I <sub>DSS</sub>	Zero Gate Voltage	VDS=24V,VGS=0V	N-CH			1	uA
	Drain Current	VDS=-24V,VGS=0V	P-CH			-1	
I <sub>GSS</sub>	Gate-Source leak current	VGS=±20V,VDS=0V	N-CH			±100	nA
		VGS=±20V,VDS=0V	P-CH			±100	
G <sub>FS</sub>	Forward Transconductance	VDS=5V,ID=5A	N-CH		7.3		S
		VDS=-5V,ID=-5A	P-CH		12		
V <sub>SD</sub>	Forward Voltage	VGS=0V,IS=1A	N-CH		0.76	1.7	V
		VGS=0V,IS=-1A	P-CH		-0.77	1.7	

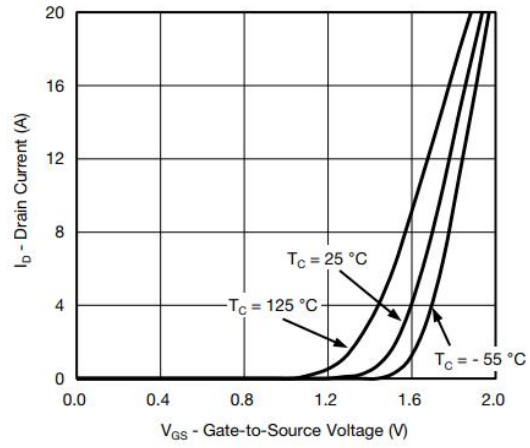
Symbol	Parameter	Test Conditions		Min	Typ.	Max	Unit
C <sub>iss</sub>	Input Capacitance	NMOS: VDS=15V, VGS=0V, F=1MHZ	N-CH		407		pF
			P-CH		950		
C <sub>oss</sub>	Output Capacitance	PMOS: VDS=-15V, VGS=0V, F=1MHZ	N-CH		113		
			P-CH		137		
C <sub>rss</sub>	Reverse Transfer Capacitance	NMOS: VDS=-15V, VGS=0V, F=1MHZ	N-CH		57		
			P-CH		118		
T <sub>D(ON)</sub>	Turn-on delay time	PMOS: VDS=15V, VGS=10V, RL=2.5R, RGEN=3R	N-CH		18		ns
			P-CH		21		
T <sub>D(OFF)</sub>	Turn-off delay time	NMOS: VDS=-15V, VGS=-10V, RL=2.5R, RGEN=3R	N-CH		70		
			P-CH		84		



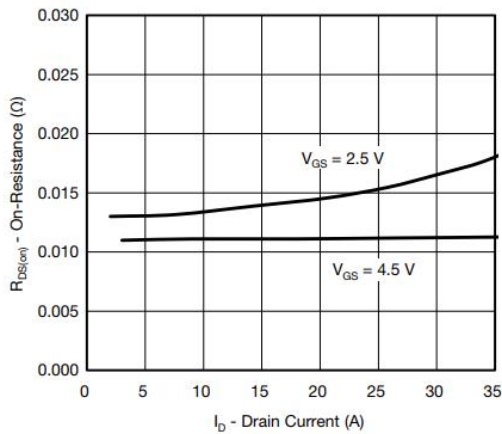
➤ **N-Channel Typical Characteristics**( $T_A=25^\circ\text{C}$  unless otherwise noted)



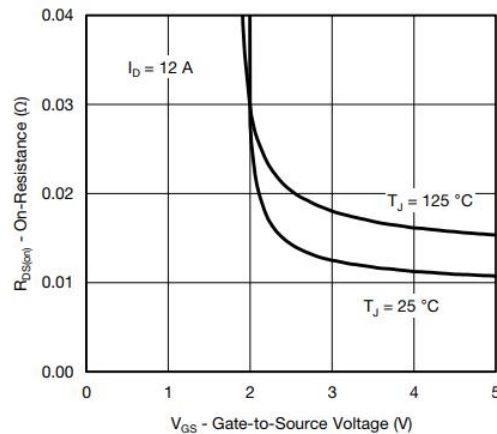
**Output Characteristics**



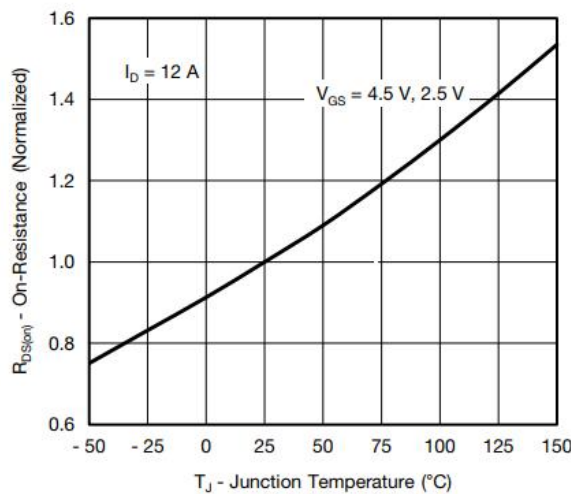
**Transfer Characteristics**



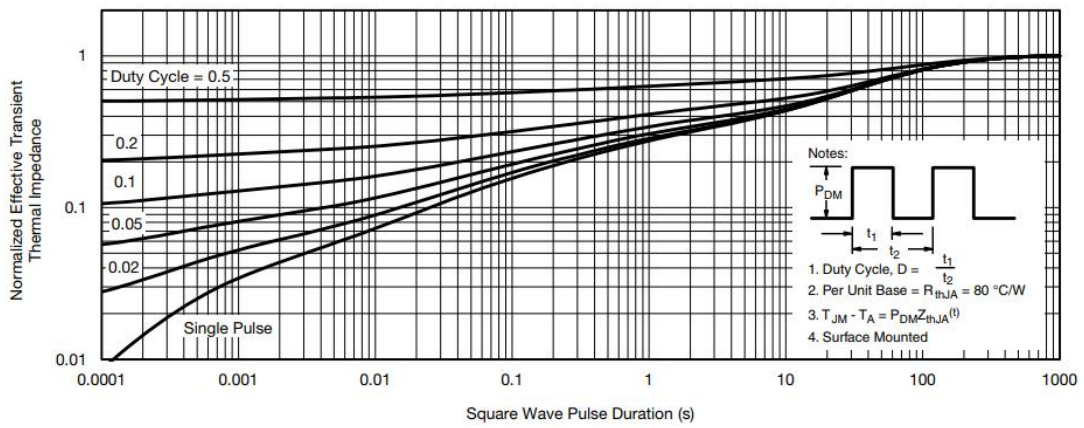
**On-Resistance vs. Drain Current and Gate Voltage**



**On-Resistance vs. Gate-to-Source Voltage**



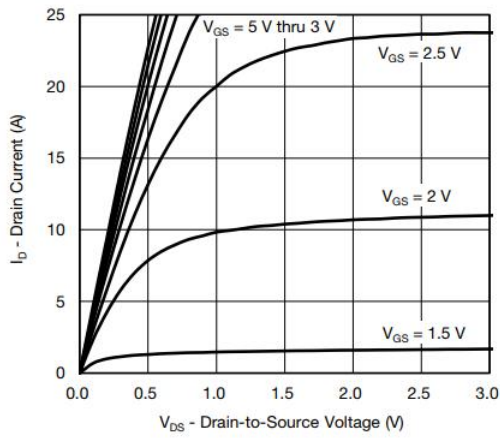
**On-Resistance vs. Junction Temperature**



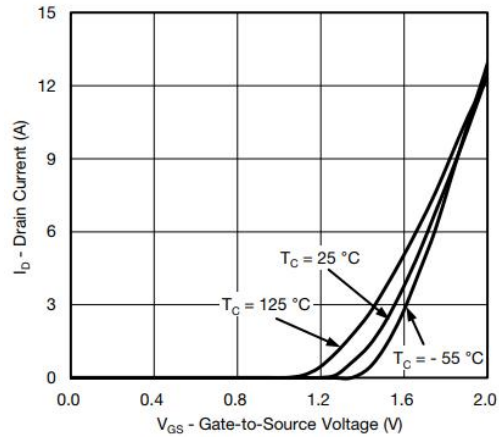
Normalized Thermal Transient Impedance, Junction-to-Ambient



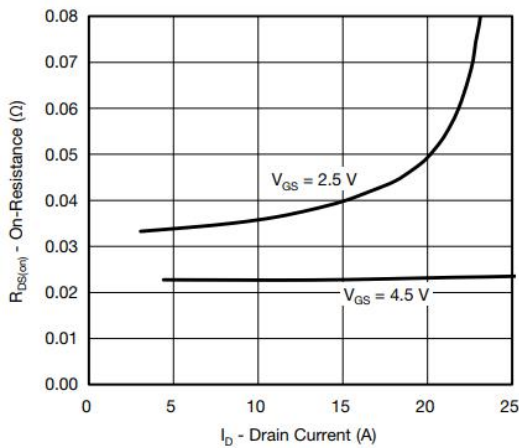
➤ **P-Channel Typical Characteristics**( $T_A=25^\circ\text{C}$  unless otherwise noted)



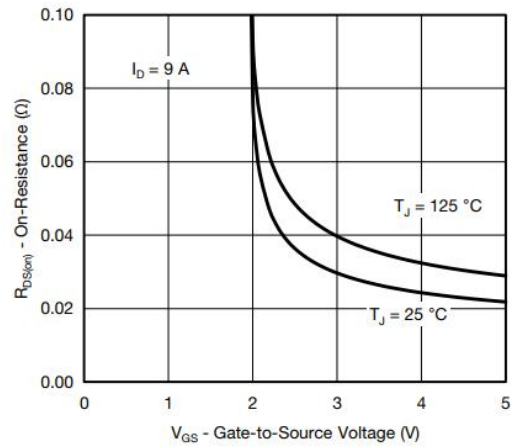
**Output Characteristics**



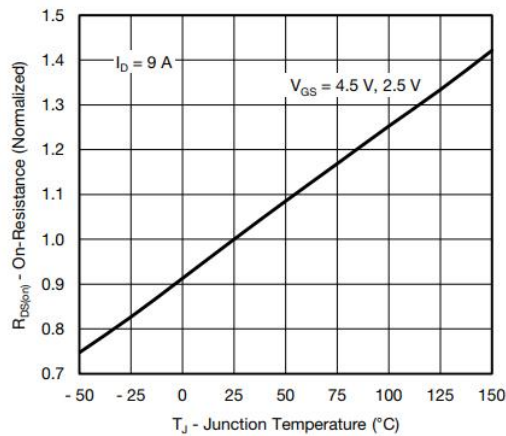
**Transfer Characteristics**



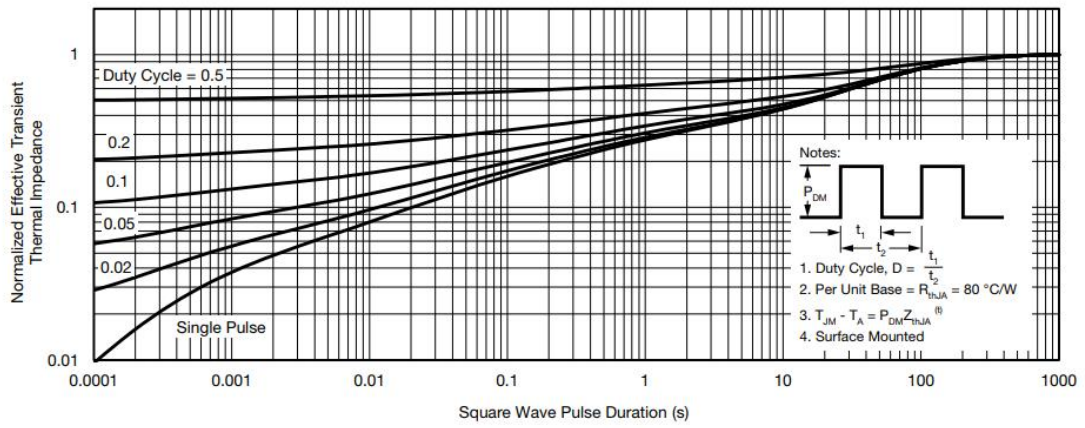
**On-Resistance vs. Drain Current and Gate Voltage**



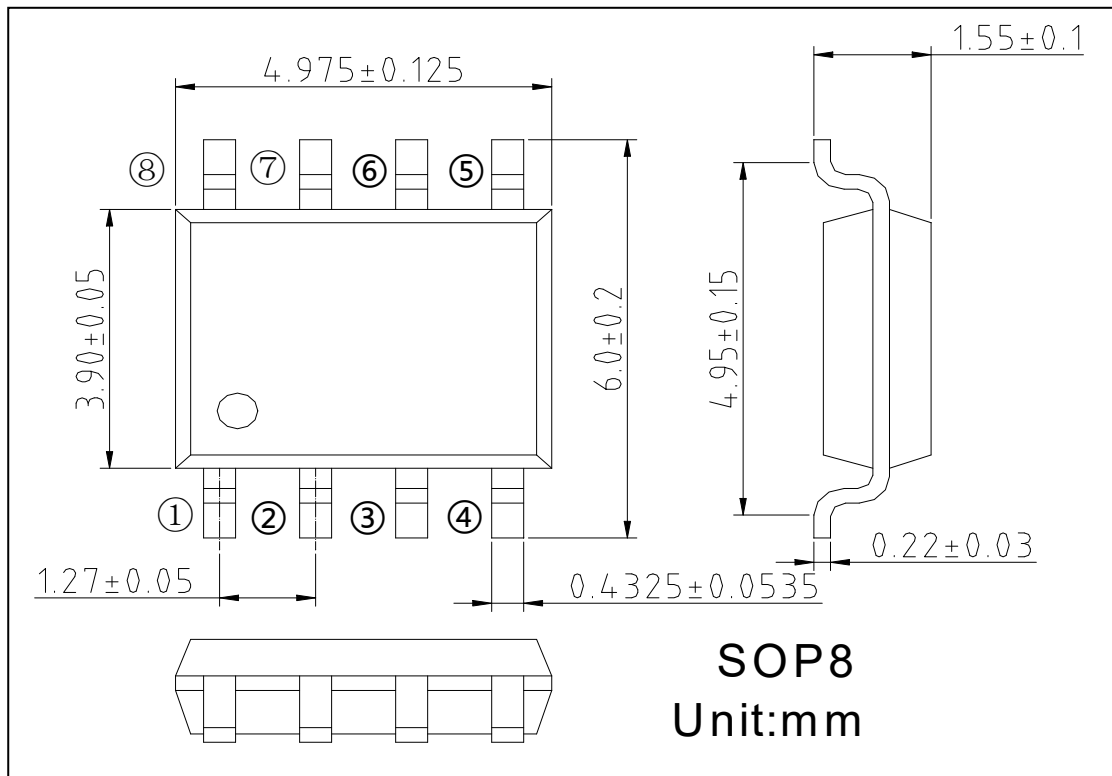
**On-Resistance vs. Gate-to-Source Voltage**



**On-Resistance vs. Junction Temperature**



Normalized Thermal Transient Impedance, Junction-to-Ambient

**➤ Package Information****DISCLAIMER**

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